## Constitutive Modeling of Thermo-Mechanical Behavior of Shape Memory Polymers

H. Jerry Qi<sup>1</sup>, Chris Yakacki<sup>1</sup>, Robin Shandas<sup>1</sup>, Ken Gall<sup>2</sup>

<sup>1</sup>Department of Mechanical Engineering University of Colorado, Boulder, CO 80309 (qih@colorado.edu)

<sup>2</sup>School of Materials Science and Engineering Georgia Institute of Technology, Atlanta, GA 30332

Shape memory polymers (SMP) are a group of polymers that are capable of recovering a predetermined shape after significant mechanical deformations. Typically, a SMP can be pre-deformed from an initial shape to a deformed shape by applying an external mechanical load at temperature  $T_d$ . A subsequently lowering down the temperature to  $T_s$  will maintain this deformed shape after the external mechanical load is removed. The shape memory effect is then activated by increasing the temperature to  $T_r$ , where the initial shape is recovered. In general,  $T_d$  and  $T_r$  are in the vicinity of the glassy transition temperature  $T_g$ , whilst  $T_s$  is below  $T_g$ . Recent advances in material science make it possible to vary the  $T_g$  by controlling chemistry or structure of SMP for a variety of applications, such as SMP based medical devices and microsystem actuation components. In these applications, it is highly desirable that the deformation history of SMP can be predicted and the recovery properties can be optimized. This, in turn, requires finite deformation constitutive models that capture the thermo-mechanical response of SMP polymers based on the fundamental understanding of structure-function relationships.

In this paper, we propose a three-dimensional constitutive model that describes the thermomechanical response of shape memory polymers. The model is based on the finite deformation theory and fundamental understanding of the structure-function relationship of SMP. Numerical simulations of a series of thermo-mechanical tests verify the efficiency of the model. Example for applying this model to complicated product design is presented.